

## BF961

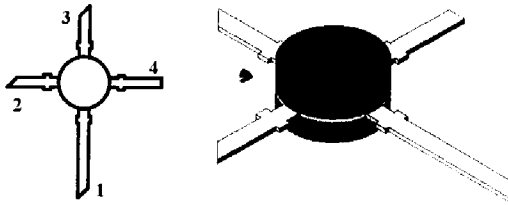
# N-Channel Dual Gate MOS-Fieldeffect Tetrode, Depletion Mode

### Applications

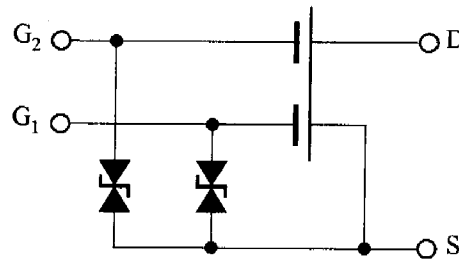
Input- and mixer stages especially for FM- and VHF TV-tuners up to 300 MHz.

### Features

- Integrated gate protection diodes
- High cross modulation performance
- Low noise figure
- High AGC-range
- Low feedback capacitance
- Low input capacitance



BF961 Marking: BF961  
 Plastic case (TO 50)  
 1=Drain, 2=Source, 3=Gate 1, 4=Gate 2



### Absolute Maximum Ratings

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

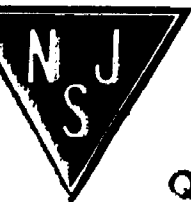
Parameter	Test Conditions	Type	Symbol	Value	Unit
Drain - source voltage			$V_{DS}$	20	V
Drain current			$I_D$	30	mA
Gate 1/Gate 2 - source peak current			$\pm I_{G1/G2SM}$	10	mA
Total power dissipation	$T_{amb} \leq 60^{\circ}\text{C}$		$P_{tot}$	200	mW
Channel temperature			$T_{Ch}$	150	$^{\circ}\text{C}$
Storage temperature range			$T_{stg}$	-55 to +150	$^{\circ}\text{C}$

### Maximum Thermal Resistance

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test Conditions	Symbol	Value	Unit
Channel ambient	on glass fibre printed board (40 x 25 x 1.5) mm <sup>3</sup> plated with 35 $\mu\text{m}$ Cu	$R_{thChA}$	450	K/W

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## Electrical DC Characteristics

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Drain - source breakdown voltage	$I_D = 10 \mu\text{A}$ , $-V_{G1S} = -V_{G2S} = 4 \text{ V}$		$V_{(BR)DS}$	20			V
Gate 1 - source breakdown voltage	$\pm I_{G1S} = 10 \text{ mA}$ , $V_{G2S} = V_{DS} = 0$		$\pm V_{(BR)G1SS}$	8		14	V
Gate 2 - source breakdown voltage	$\pm I_{G2S} = 10 \text{ mA}$ , $V_{G1S} = V_{DS} = 0$		$\pm V_{(BR)G2SS}$	8		14	V
Gate 1 - source leakage current	$\pm V_{G1S} = 5 \text{ V}$ , $V_{G2S} = V_{DS} = 0$		$\pm I_{G1SS}$			100	nA
Gate 2 - source leakage current	$\pm V_{G2S} = 5 \text{ V}$ , $V_{G1S} = V_{DS} = 0$		$\pm I_{G2SS}$			100	nA
Drain current	$V_{DS} = 15 \text{ V}$ , $V_{G1S} = 0$ , $V_{G2S} = 4 \text{ V}$	BF961	$I_{DSS}$	4		20	mA
		BF961A	$I_{DSS}$	4		10.5	mA
		BF961B	$I_{DSS}$	9.5		20	mA
Gate 1 - source cut-off voltage	$V_{DS} = 15 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $I_D = 20 \mu\text{A}$		$-V_{G1S(OFF)}$			3.5	V
Gate 2 - source cut-off voltage	$V_{DS} = 15 \text{ V}$ , $V_{G1S} = 0$ , $I_D = 20 \mu\text{A}$		$-V_{G2S(OFF)}$			3.5	V

## Electrical AC Characteristics

$V_{DS} = 15 \text{ V}$ ,  $I_D = 10 \text{ mA}$ ,  $V_{G2S} = 4 \text{ V}$ ,  $f = 1 \text{ MHz}$ ,  $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Forward transadmittance		$ y_{21s} $	12	15		mS
Gate 1 input capacitance		$C_{issg1}$		3.7		pF
Gate 2 input capacitance	$V_{G1S} = 0$ , $V_{G2S} = 4 \text{ V}$	$C_{issg2}$		1.6		pF
Feedback capacitance		$C_{rss}$		25		fF
Output capacitance		$C_{oss}$		1.6		pF
Power gain	$G_S = 2 \text{ mS}$ , $G_L = 0.5 \text{ mS}$ , $f = 200 \text{ MHz}$	$G_{ps}$		20		dB
AGC range	$V_{G2S} = 4 \text{ to } -2 \text{ V}$ , $f = 200 \text{ MHz}$	$\Delta G_{ps}$		50		dB
Noise figure	$G_S = 2 \text{ mS}$ , $G_L = 0.5 \text{ mS}$ , $f = 200 \text{ MHz}$	F		1.8	2.5	dB

